# DISCRETE SEMICONDUCTORS

# DATA SHEET

# **BLU97**UHF power transistor

**Product specification** 

August 1986





# **UHF** power transistor

**BLU97** 

#### **DESCRIPTION**

N-P-N silicon planar epitaxial transistor designed for use in mobile radio transmitters in the 470 MHz band.

#### **FEATURES**

- multi-base structure and emitter-ballasting resistors for an optimum temperature profile.
- gold metallization ensures excellent reliability.

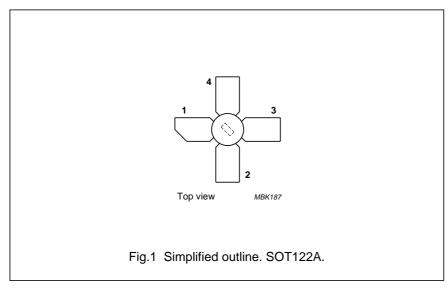
The transistor has a 4-lead stud envelope with a ceramic cap (SOT122A). All leads are isolated from the stud.

# **QUICK REFERENCE DATA**

R.F. performance up to  $T_h = 25$  °C in a common-emitter class-B circuit

MODE OF OPERATION	V <sub>CE</sub>	f	P <sub>L</sub>	G <sub>p</sub>	η <b>c</b>
	V	MHz	W	dB	<b>%</b>
narrow band; c.w.	12,5	470	7	> 8,5	> 55

#### **PIN CONFIGURATION**



#### **PINNING - SOT122A.**

PIN	DESCRIPTION
1	collector
2	emitter
3	base
4	emitter

PRODUCT SAFETY This device incorporates beryllium oxide, the dust of which is toxic. The device is entirely safe provided that the BeO disc is not damaged.

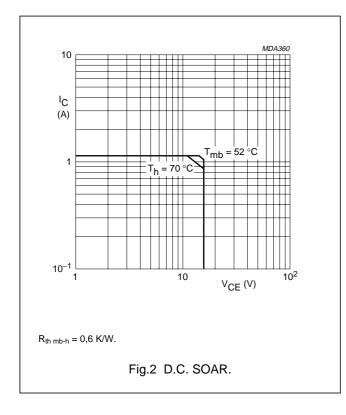
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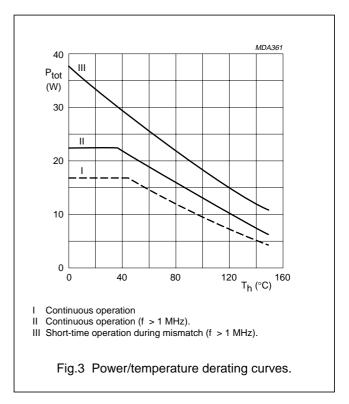
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# **RATINGS**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

$V_{\sf CBO}$	max.	36	V
$V_{\sf CEO}$	max.	16	٧
$V_{EBO}$	max.	3	٧
I <sub>C</sub>	max.	1,2	Α
I <sub>CM</sub>	max.	3,6	Α
$P_{tot(d.c.)}$	max.	17	W
$P_{tot(r.f.)}$	max.	22,5	W
$T_{stg}$	−65 to	+150	°С
$T_{j}$	max.	200	°С
	V <sub>CEO</sub> V <sub>EBO</sub> I <sub>C</sub> I <sub>CM</sub> P <sub>tot(d.c.)</sub> P <sub>tot(r.f.)</sub> T <sub>stg</sub>	$\begin{array}{ccc} V_{CEO} & \text{max.} \\ V_{EBO} & \text{max.} \\ \\ I_{C} & \text{max.} \\ \\ I_{CM} & \text{max.} \\ \\ \\ P_{tot(d.c.)} & \text{max.} \\ \\ P_{tot(r.f.)} & \text{max.} \\ \\ T_{stg} & -65 \text{ to} \\ \end{array}$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$





# THERMAL RESISTANCE

Dissipation = 15 W;  $T_{mb}$  = 25 °C

From junction to mounting base

(d.c. dissipation)

(r.f. dissipation)

From mounting base to heatsink

R <sub>th j-mb(dc)</sub>	=	7,5 K/W
R <sub>th j-mb(rf)</sub>	=	5,6 K/W
$R_{th\ mb-h}$	=	0.6 K/W

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# **CHARACTERISTICS**

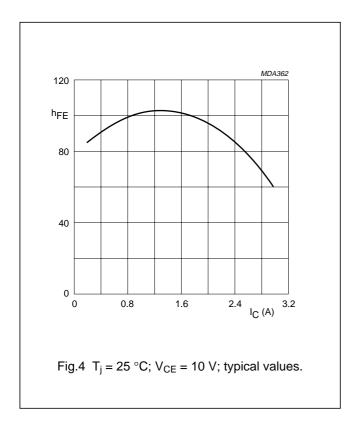
 $T_j = 25$  °C unless otherwise specified

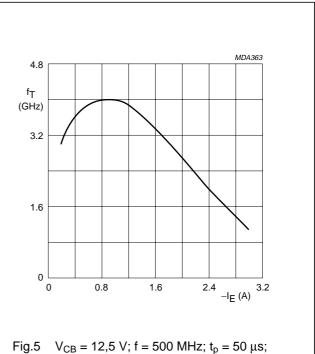
$V_{(BR)CBO}$	>	36 V
$V_{(BR)CEO}$	>	16 V
$V_{(BR)EBO}$	>	3 V
I <sub>CES</sub>	<	7,5 mA
$E_SBR$	>	2,3 mJ
h	>	25
''FE	typ.	100
$f_T$	typ.	4,0 GHz
C <sub>c</sub>	typ.	10 pF
$C_{re}$	typ.	7 pF
C <sub>cs</sub>	typ.	1,2 pF
	V <sub>(BR)</sub> CEO V <sub>(BR)</sub> EBO I <sub>CES</sub> E <sub>SBR</sub> h <sub>FE</sub> f <sub>T</sub> C <sub>c</sub> C <sub>re</sub>	$\begin{array}{c} V_{(BR)CEO} & > \\ V_{(BR)EBO} & > \\ I_{CES} & < \\ E_{SBR} & > \\ h_{FE} & typ. \\ f_T & typ. \\ C_c & typ. \\ C_{re} & typ. \\ \end{array}$

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# Note

1. Measured under pulse conditions:  $t_p$  = 50  $\mu s;\,\delta <$  1%.



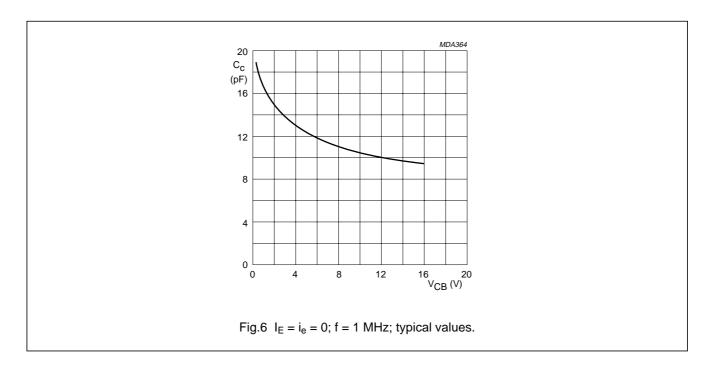


 $\begin{array}{ll} \mbox{Fig.5} & \mbox{V}_{CB} = 12, \mbox{S V; f} = 500 \mbox{ MHz; } t_p = 50 \mbox{ } \mu \mbox{s;} \\ \mbox{T}_j = 25 \mbox{ }^{\circ}\mbox{C; typical values.} \end{array}$ 

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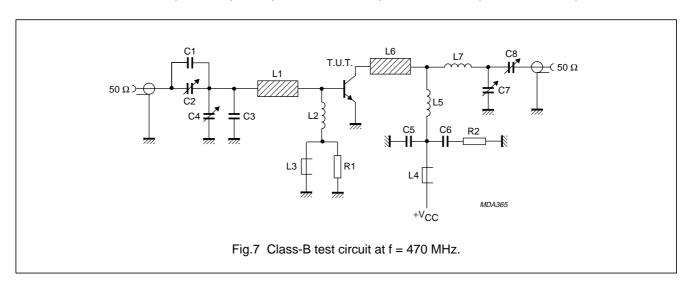
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# **APPLICATION INFORMATION**

R.F. performance in common-emitter circuit; class-B: f = 470 MHz;  $T_h$  = 25 °C

MODE OF OPERATION	V <sub>CE</sub> V	P <sub>L</sub> W	P <sub>S</sub> W		G <sub>p</sub> dB		I <sub>C</sub> A			η <b>c</b> %	
narrow hand: a w	10.5	7	<	0,99	>	8,5	<	1,0	>	55	
narrow band; c.w.	12,5	′	typ.	0,55	typ.	11,0	typ.	0,8	typ.	70	



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# List of components:

- C1 = 2,7 pF multilayer ceramic chip capacitor<sup>(1)</sup>
- C2 = C7 = C8 = 1,4 to 5,5 pF film dielectric trimmer (cat. no. 2222 809 09001)
- C3 = 7,5 pF multilayer ceramic chip capacitor<sup>(1)</sup>
- C4 = 2 to 9 pF film dielectric trimmer (cat. no. 2222 809 09002)
- C5 = 100 pF multilayer ceramic chip capacitor
- C6 = 100 nF metallized film capacitor
- L1 =  $38 \Omega$  stripline (22,5 mm × 6,0 mm)
- L2 = 15 nH; 1 turn Cu wire (1,0 mm); int. dia. 5 mm; leads  $2 \times 5$  mm
- L3 = L4 = Ferroxcube wideband h.f. choke, grade 3B (cat. no. 4312 020 36642)
- L5 = 29 nH; 2 turns enamelled Cu wire (1,0 mm); int. dia. 6 mm; length 3,5 mm; leads 2 × 5 mm
- L6 =  $38 \Omega$  stripline (10,0 mm  $\times$  6,0 mm)
- L7 = 7 nH; 1/2 turn Cu wire (1,0 mm); int. dia. 5,0 mm; leads  $2 \times 5 \text{ mm}$
- R1 = R2 =  $10 \Omega \pm 10\%$ ; 0,25 W metal film resistor

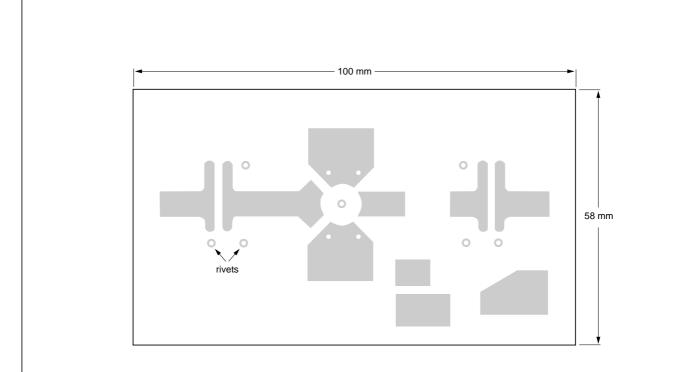
L1 and L6 are striplines on a double Cu-clad printed circuit board with P.T.F.E. fibre-glass dielectric ( $\epsilon_r$  = 2,74); thickness  $^{1}\!\!/_{16}$  inch.

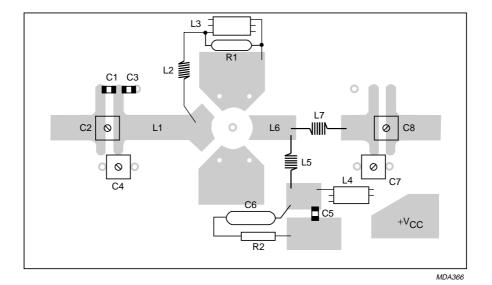
#### Note

1. American Technical Ceramics capacitor type 100A or capacitor of same quality.

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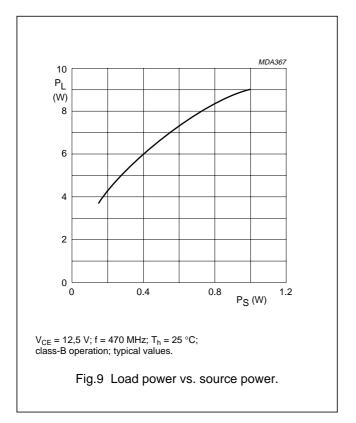
The circuit and the components are on one side of the P.T.F.E. fibre-glass board; the other side is unetched copper serving as ground plane. Earth connections are made by hollow rivets and also by copper straps under the

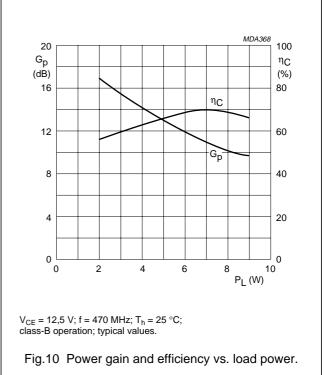
Fig.8 Printed circuit board and component lay-out for 470 MHz class-B test circuit.

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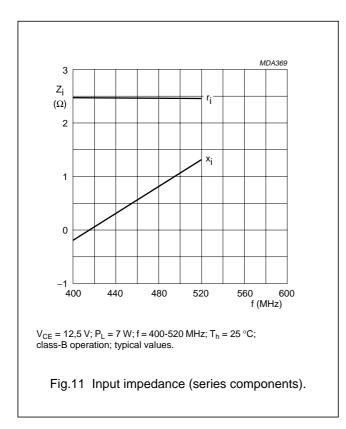


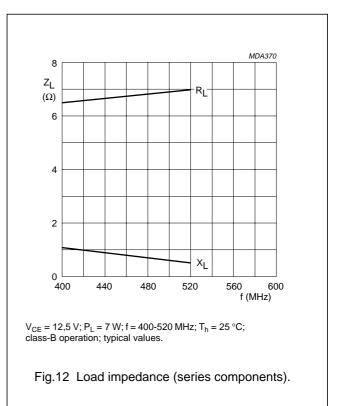
# **RUGGEDNESS**

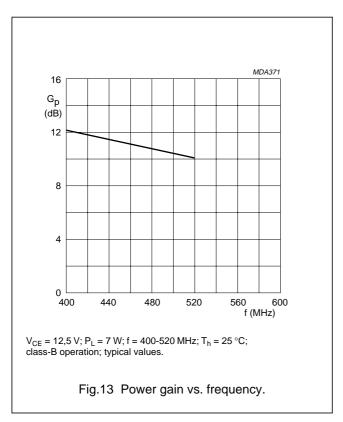
The device is capable of withstanding a full load mismatch (VSWR = 50; all phases) at rated load power up to a supply voltage of 15,5 V and  $T_h$  = 25 °C.

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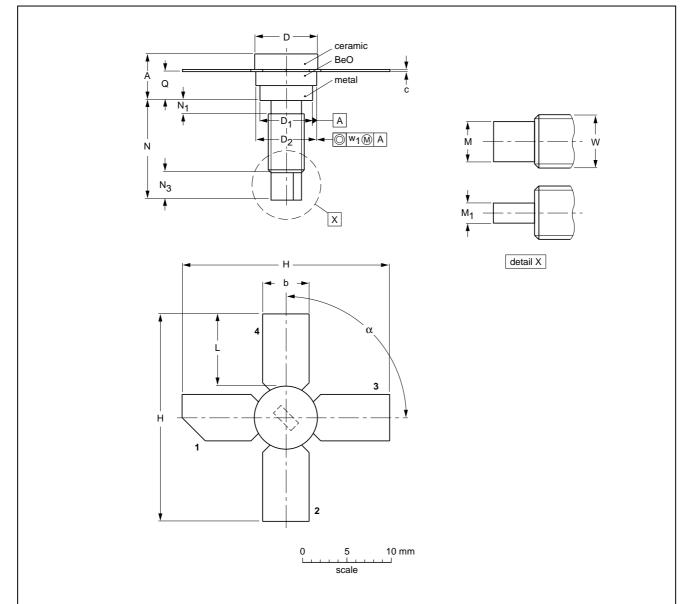
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# **PACKAGE OUTLINE**

Studded ceramic package; 4 leads

SOT122A



# DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	Α	b	С	D	D <sub>1</sub>	D <sub>2</sub>	н	L	М1	М	N	N <sub>1</sub> max.	N <sub>3</sub>	Q	w	w <sub>1</sub>	α
mm	5.97 4.74	5.85 5.58	0.18 0.14	7.50 7.23	6.48 6.22	7.24 6.93	27.56 25.78	9.91 9.14	3.18 2.66	1.66 1.39	11.82 11.04	1.02	3.86 2.92	3.38 2.74	8-32 UNC	0.381	90°

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1330E DATE
SOT122A						97-04-18

Product specification Philips Semiconductors

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#### **DEFINITIONS**

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

#### **Application information**

Where application information is given, it is advisory and does not form part of the specification.

#### LIFE SUPPORT APPLICATIONS

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